N-Channel 40 V (D-S) MOSFET

PRODUCT SUMMARY						
V _{DS} (V)	R _{DS(on)} (mΩ) (TYP.)	I _D (A) ^{a,e}	Q _g (TYP.)			
40	0.58 at V _{GS} = 10 V	240	97 nC			

FEATURES

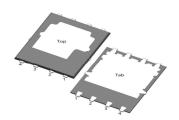
- DT-Trench Power MOSFET
- 100 % $\rm R_{\rm g}$ and UIS Tested

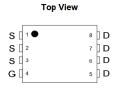


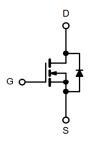
APPLICATIONS

- · Notebook PC Core
- VRM/POL

DFN5*6 Double Cooling







N-Channel MOSFET

Parameter	Symbol	Limit	Unit		
Drain-Source Voltage	V _{DS}	40	V		
Gate-Source Voltage		V_{GS}			± 20
	T _C = 25 °C		240 ^{a,e}		
Continuous Drain Current (T _J = 175 °C)	T _C =70 °C	_	215		
Continuous Drain Current (1, = 175 C)	T _A = 25 °C	I _D	59 ^{b, c}	A	
	T _A = 70 °C		38 ^{b, c}		
Pulsed Drain Current		I _{DM}	900		
Avalanche Current Pulse	L = 0.1 mH	I _{AS}	220		
Single Pulse Avalanche Energy	L = 0.111111	E _{AS}	910	mJ	
Continuous Source-Drain Diode Current	T _C = 25 °C	I _S	240 ^a	Α Α	
Commuous Source-Drain Diode Current	T _A = 25 °C	'S	56 ^{b, c}	A	
	T _C = 25 °C		370 ^a		
Maximum Power Dissipation	T _C = 70 °C	P_{D}	237	w	
Maximum Fower Dissipation	T _A = 25 °C		52 ^{b, c}	VV	
	T _A = 70 °5		36 ^{b, c}		
Operating Junction and Storage Temperature Range		T _J , T _{stg}	- 55 to 175	°C	

THERMAL RESISTANCE RATINGS						
Parameter		Symbol	Typical	Maximum	Unit	
Maximum Junction-to-Ambient ^{b, d}	t ≤ 10 s	R _{thJA}	1.5	2.9	°C/W	
Maximum Junction-to-Case	Steady State	R _{thJC}	0.25	0.4	5/ VV	

- a. Based on T_C = 25 °C. b. Surface mounted on 1" x 1" FR4 board.
- c. t = 10 s.
 d. Calculated based on maximum junction temperature.
- e. Package limited.

Rev. 1.0

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Parameter	Symbol	Test Conditions	Min .	Тур.	Max.	Unit	
Static							
Drain-Source Breakdown Voltage	V _{DS}	$V_{GS} = 0 \text{ V, I}_{D} = 250 \mu\text{A}$	40			V	
V _{DS} Temperature Coefficient	ΔV _{DS} /T _J	I _D = 250 μA		25		mV/°C	
V _{GS(th)} Temperature Coefficient	$\Delta V_{GS(th)}/T_J$	10 - 200 μΛ		- 6.2] IIIV/ C	
Gate-Source Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	1.5		3.5	V	
Gate-Source Leakage	I _{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$			± 100	nA	
Zoro Coto Voltago Drain Current	1	$V_{DS} = 40 \text{ V}, V_{GS} = 0 \text{ V}$			1		
Zero Gate Voltage Drain Current	DSS	$V_{DS} = 32 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 55 ^{\circ}\text{C}$			10	μA	
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \ge 5 \text{ V}, V_{GS} = 10 \text{ V}$	240			Α	
Drain-Source On-State Resistance ^a	R _{DS(on)}	$V_{GS} = 10 \text{ V}, I_D = 30 \text{ A}$		0.58	0.8	mΩ	
Forward Transconductance ^a	9 _{fs}	$V_{DS} = 5 \text{ V}, I_{D} = 30 \text{ A}$		120		S	
Dynamic ^b	,			,			
Input Capacitance	C _{iss}			6750		pF	
Output Capacitance	C _{oss}	V_{DS} = 20 V, V_{GS} = 0 V, f = 1 MHz		2120			
Reverse Transfer Capacitance	C _{rss}			190			
Total Gate Charge	Qg			97		nC	
Gate-Source Charge	Q _{gs}	$V_{DS} = 20 \text{ V}, V_{GS} = 10 \text{ V}, I_{D} = 30 \text{ A}$		19			
Gate-Drain Charge	Q _{gd}			13			
Gate Resistance	R _g	f = 1 MHz		1.5		Ω	
Turn-On Delay Time	t _{d(on)}			26			
Rise Time	t _r	V_{DD} = 15 V, R_L = 0.555 Ω		10		ns	
Turn-Off Delay Time	t _{d(off)}	$I_D \cong 30A$, $V_{GEN} = 10 \text{ V}$, $R_g = 1 \Omega$		65			
Fall Time	t _f			10			
Drain-Source Body Diode Characteristic	s						
Continuous Source-Drain Diode Current	I _S	T _C = 25 °C			240	Α	
Pulse Diode Forward Current ^a	I _{SM}				900		
Body Diode Voltage	V _{SD}	I _S = 1 A		0.6	1.2	V	
Body Diode Reverse Recovery Time	t _{rr}			26		ns	
Body Diode Reverse Recovery Charge	Q _{rr}	I _F = 30 A, di/dt = 100 A/μs, T _J = 25 °C		90		nC	
Reverse Recovery Fall Time	t _a	$_{1F} = 30 \text{ A}, \text{ di/dt} = 100 \text{ A/} \mu \text{s}, \text{ 1J} = 25 \text{ C}$		27		ns	
Reverse Recovery Rise Time	t _b			25			

Notes:

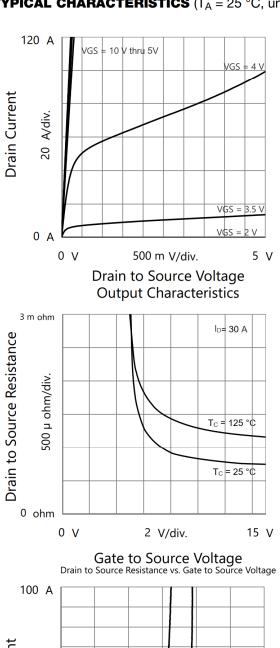
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

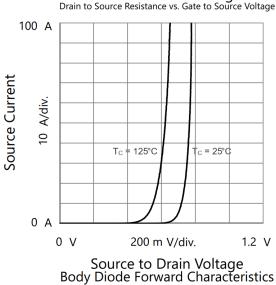
a. Pulse test; pulse width \leq 300 µs, duty cycle \leq 2 %.

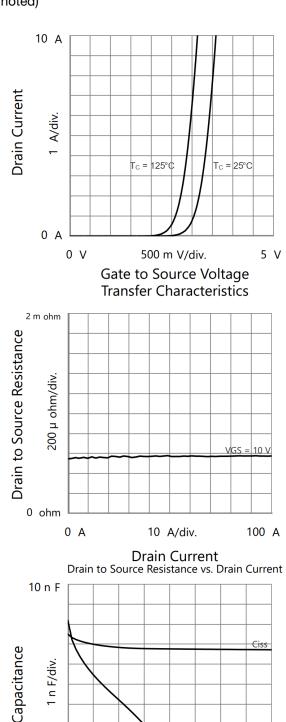
b. Guaranteed by design, not subject to production testing.

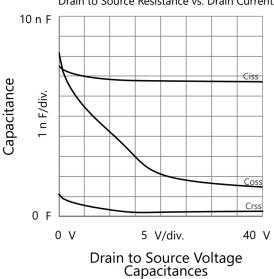


TYPICAL CHARACTERISTICS (T_A = 25 °C, unless otherwise noted)



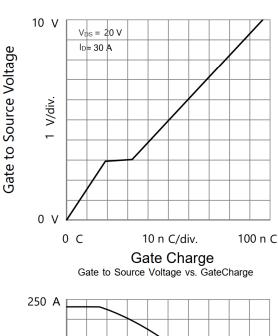


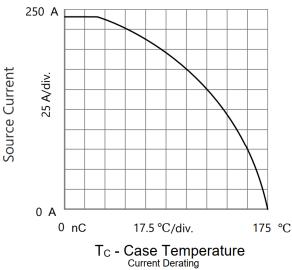


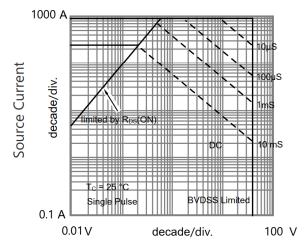


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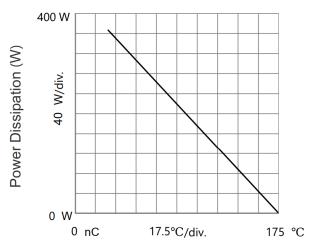
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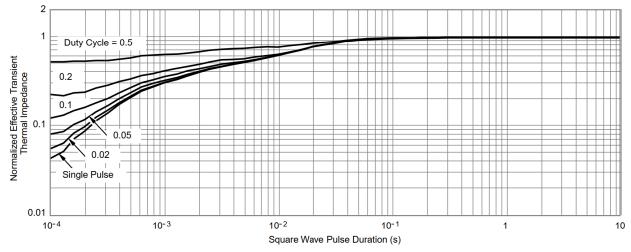




Source to Drain Voltage Safe Operating Area, Junction-to-Ambient



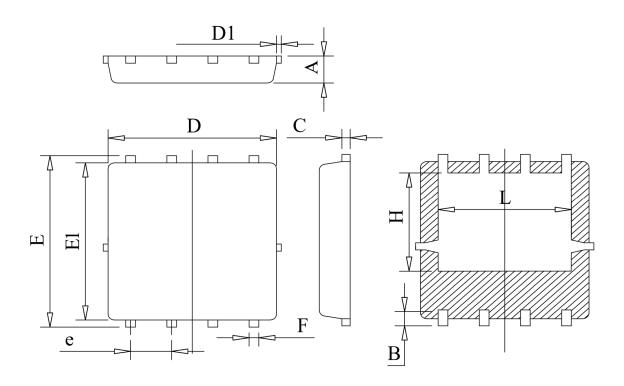
T_C - Case Temperature
Current Derating



Normalized Thermal Transient Impedance, Junction-to-Case



DFN5X6-8L PACKAGE OUTLINE



COMMON DIMENSIONS (UNITS OF MEASURE=MILLIMETER)

Unit: mm

Symbol	Min	Тур	Max
A	0.78	0.95	1.12
В	0.45	0.58	0.78
С	0.18	0.254	0.36
D	4.70	5.20	5.45
D1			0.18
Е	5.85	6.05	6.25
E1	5.38	5.55	5.98
e	1.15	1.27	1.40
F	0.18	0.30	0.52
Н	3.25	3.47	3.70
L	3.75	4.00	4.25

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